

### **Features**

- ESD protection for one line with uni-directional
- Provide transient protection for each line to IEC 61000-4-2 (ESD) ±30kV (air / contact)
   IEC 61000-4-4 (EFT) ±80A (5/50ns)
   IEC 61000-4-5 (Lightning) 15A (8/20µs)
- Suitable for, 9V and below, operating voltage applications
- 0201 small MCSP package saves board space
- Protect one I/O line or one power line
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- Green part

### **Applications**

- Power supply protection
- USB power delivery
- Small panel modules
- Handheld portable applications
- Low speed data or control line protection
- Peripherals
- Consumer electronics

### **Description**

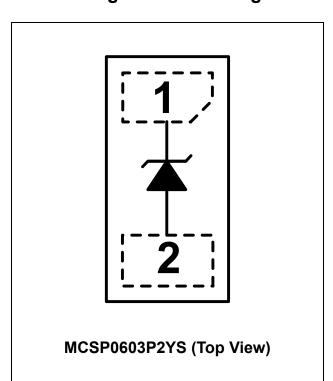
AZ4U09-01M is a design which includes a uni-directional surge rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic system. The AZ4U09-01M has been specifically designed to protect sensitive components which are connected to power and control lines from

over-voltage damage caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

AZ4U09-01M is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ4U09-01M may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

### **Circuit Diagram / Pin Configuration**





## **Specifications**

<b>Absolute Maximum Ratings</b> (T <sub>A</sub> = 25°C, unless otherwise specified)				
Parameter	Symbol	Rating	Unit	
Peak Pulse Current (t <sub>p</sub> =8/20μs) (Note 1)	I <sub>PP</sub>	15	А	
Operating Voltage	V <sub>DC</sub>	9.9	V	
ESD per IEC 61000-4-2 (Air)	V <sub>ESD-1</sub>	±30	141/	
ESD per IEC 61000-4-2 (Contact)	$V_{ESD-2}$	±30	kV	
Lead Soldering Temperature	T <sub>SOL</sub>	260 (10 sec.)	°C	
Operating Temperature	T <sub>OP</sub>	-55 to +125	°C	
Storage Temperature	T <sub>STO</sub>	-55 to +150	°C	

Electrical Characteristics						
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Reverse Stand-Off Voltage	$V_{RWM}$	Pin-1 to pin-2, T=25 °C.			9	V
Reverse Leakage Current	I <sub>Leak</sub>	$V_{RWM}$ = 9V, T=25 °C, pin-1 to pin-2.			0.1	μΑ
Reverse Breakdown Voltage	$V_{BV}$	$V_{BV}$ $I_{BV} = 1$ mA, T=25 °C, pin-1 to pin-2.			13.5	V
Forward Voltage	V <sub>F</sub>	$I_F$ = 15mA, T=25 °C, pin-2 to pin-1.	0.5		1	٧
Surge Clamping Voltage (Note 1)	$I_{PP} = 5A$ , $t_p = 8/20\mu s$ , $T=25^{\circ}C$ .		12.5		V	
	V CL-surge	$I_{PP} = 15A$ , $t_p = 8/20\mu s$ , $T=25^{\circ}C$ .		14.5		V
ESD Clamping Voltage (Note 2)	V <sub>CL-ESD</sub>	IEC 61000-4-2 +8kV (I <sub>TLP</sub> = 16A), contact mode, T=25 °C, pin-1 to pin-2.		13		V
ESD Dynamic Turn-on Resistance	R <sub>dynamic</sub>	IEC 61000-4-2 0~+8kV, T=25 °C, contact mode, pin-1 to pin-2.		0.09		Ω
Channel Input Capacitance	C <sub>IN</sub>	$V_R = 0V$ , $f = 1MHz$ , pin-1 to pin-2, $T=25$ °C.		58	70	pF

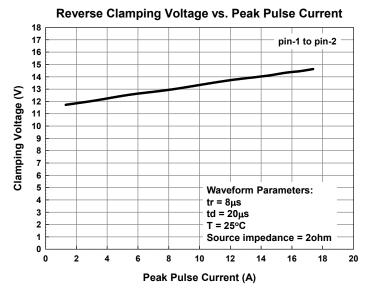
Note 1: The Peak Pulse Current measured conditions:  $t_p$  = 8/20 $\mu$ s,  $2\Omega$  source impedance.

Note 2: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

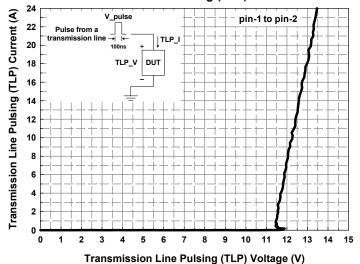
TLP conditions:  $Z_0 = 50\Omega$ ,  $t_p = 100$ ns,  $t_r = 1$ ns.



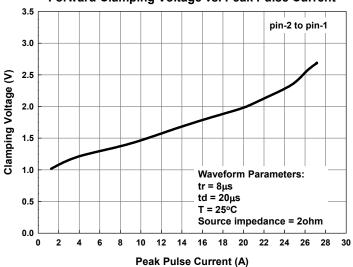
## **Typical Characteristics**



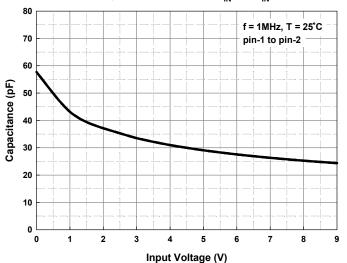




### Forward Clamping Voltage vs. Peak Pulse Current



Typical Variation of C<sub>IN</sub> vs. V<sub>IN</sub>





### **Applications Information**

The AZ4U09-01M is designed to protect one line against system ESD / EFT / Lightning pulses by clamping it to an acceptable reference.

The usage of the AZ4U09-01M is shown in Fig. 1. Protected lines, such as data lines, control lines, or power lines, are connected to pin 1. The pin 2 should be connected directly to a ground plane on the board. All path lengths connected to the pins of AZ4U09-01M should be kept as short as possible to minimize parasitic inductance in the board traces.

In order to obtain enough suppression of ESD induced transient, a good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ4U09-01M.
- Place the AZ4U09-01M near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

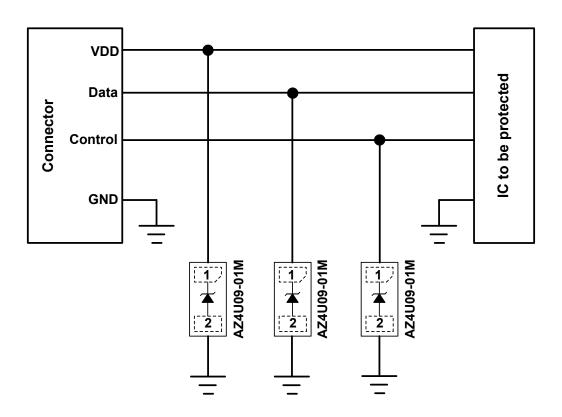
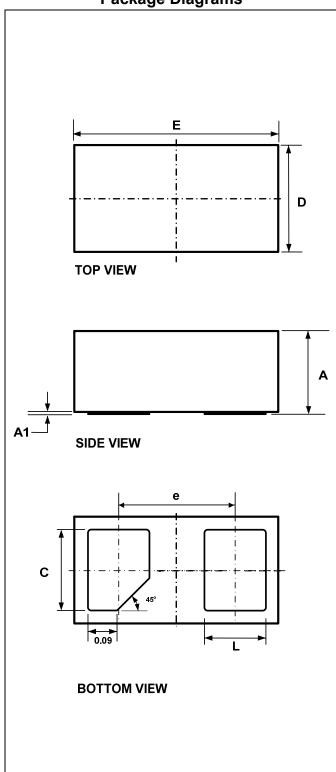


Fig. 1



# Mechanical Details MCSP0603P2YS

### **Package Diagrams**

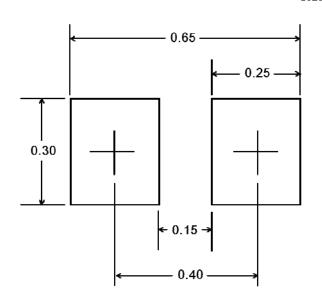


### **Package Dimensions**

SYMBOL	MILLIMETERS			
	MIN.	NOM.	MAX.	
E	0.615	0.630	0.645	
D	0.315	0.330	0.345	
Α	0.235	0.250	0.265	
<b>A</b> 1	0.005	0.015	0.050	
L	0.170	0.190	0.210	
С	0.230	0.250	0.270	
е		0.360 BSC		

## **Land Layout**

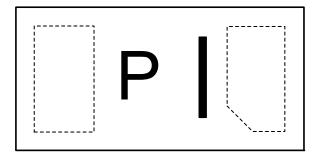
Unit: mm



#### Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

## **Marking Code**



P=	Device	Code
ı —	Device	Couc

Part Number	Marking Code	
AZ4U09-01M.R7G (Green Part)	Р	

Note: Green means Pb-free, RoHS, and Halogen free compliant.

# **Ordering Information**

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ4U09-01M.R7G	Green	T/R	7 inch	15,000/reel	4  reels = 60,000/box	6 boxes = 360,000/carton

# **Revision History**

Revision	Modification Description
Revision 2023/07/25	Formal Release.